GD50HCU120C5S IGBT Module

STARPOWER

SEMICONDUCTOR™

IGBT

GD50HCU120C5S

Preliminary

Molding Type Module

1200V/50A 4 in one-package

General Description

STARPOWER IGBT Power Module provides ultrafast switching speed as well as short circuit ruggedness. It's designed for the applications such as electrical welding and inductive heating.



Features

- Low V_{CE(sat)} NPT IGBT technology
- 10µs short circuit capability
- V_{CE(sat)} with positive temperature coefficient
- Rugged with ultrafast performance
- Square RBSOA
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

Typical Applications

- Switching mode power supplies
- Inductive heating
- Electrical welding

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IGBT-inverter T_C=25 °C unless otherwise noted

Maximum Rated Values

Symbol	Description	GD50HCU120C5S	Units	
V_{CES}	Collector-Emitter Voltage @ T _j =25°C	1200	V	
V_{GES}	Gate-Emitter Voltage	±20	V	
$I_{\rm C}$	Collector Current @ T _C =25°C	75	Α.	
	@ T _C =80°C	50	Α	
I_{CM}	Pulsed Collector Current t _p =1ms	100	A	
P _{tot}	Total Power Dissipation @ T _j =150°C	417	W	
T_{SC}	Short Circuit Withstand Time @ T _j =125°C	10	μs	

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _{(BR)CES}	Collector-Emitter	T-25°C	1200	0		17
	Breakdown Voltage	T _j =25℃				·
I _{CES}	Collector Cut Off Current	$V_{\text{CE}}=V_{\text{CES}}, V_{\text{GE}}=0V,$			1.0	mA
	Collector Cut-Off Current	T _j =25℃				
I _{GES}	Gate-Emitter Leakage	$V_{GE}=V_{GES}, V_{CE}=0V,$			400	nA
	Current	T _j =25 ℃			400	

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
$V_{\text{GE(th)}}$	Gate-Emitter	$I_{C}=500\mu A, V_{CE}=V_{GE},$	4.4	5.2	6.0	V
	Threshold Voltage	T _j =25℃	4.4	3.2	0.0	V
V _{CE(sat)}	Collector to Emitter	$I_{C}=50A, V_{GE}=15V, T_{j}=25^{\circ}C$		3.15	3.60	W
	Saturation Voltage	$I_{C}=50A, V_{GE}=15V, T_{j}=125 ^{\circ}C$		3.60]

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time			262		ns
t _r	Rise Time			52		ns
$t_{d(off)}$	Turn-Off Delay Time	V -600VI -50A		272		ns
$t_{\rm f}$	Fall Time	$V_{CC}=600V,I_{C}=50A,$ $R_{G}=13\Omega,V_{GE}=\pm 15V,$ $T_{j}=25^{\circ}C$		116		ns
Eon	Turn-On Switching			4.69		mJ
	Loss					
E	Turn-Off Switching			1.89		mJ
E _{off}	Loss					
$t_{d(on)}$	Turn-On Delay Time	V_{CC} =600V, I_{C} =50A, R_{G} =13 Ω , V_{GE} = \pm 15V, T_{j} =125 $^{\circ}$ C		276		ns
t_r	Rise Time			53		ns
$t_{d(off)}$	Turn-Off Delay Time			290		ns
t_{f}	Fall Time			146		ns

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Eon	Turn-On Switching Loss	V_{CC} =600V, I_{C} =50A, R_{G} =13 Ω , V_{GE} = \pm 15V, T_{j} =125 $^{\circ}$ C	5.92	mJ
E_{off}	Turn-Off Switching Loss		2.69	mJ
Cies	Input Capacitance		4300	pF
Coes	Output Capacitance	V _{CE} =30V,f=1Mhz, V _{GE} =0V	330	pF
C_{res}	Reverse Transfer Capacitance		160	pF
I_{SC}	SC Data	$T_P \le 10 \mu s, V_{GE} = 15 V,$ $T_j = 125 ^{\circ}C, V_{CC} = 900 V,$ $V_{CEM} \le 1200 V$	TBD	A

DIODE-inverter T_C =25°C unless otherwise noted

Maximum Rated Values

Symbol	Description	GD50HCU120C5S	Units
V_{RRM}	Collector-Emitter Voltage @ T _j =25°C	1200	V
I_F	DC Forward Current	50	A
I_{FRM}	Repetitive Peak Forward Current t _p =1ms	100	A
I^2t	I^2 t-value, V_R =0 V , t_p =10ms, T_j =125°C	1250	A^2s

Characteristics Values

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
X 7	Diode Forward	I -50 A W -0W	T _j =25℃		1.82	2.25	V
V_{F}	Voltage	$I_F=50A, V_{GE}=0V$	T _j =125℃		1.95] V
Qr	Dagayarad Charga		T _j =25℃		3.5		μС
	Recovered Charge	$I_F=50A$,	T _j =125℃		9.0		
I_{RM}	Peak Reverse	$V_R = 600V$,	T _j =25℃		23		Α.
	Recovery Current	di/dt=-1100A/μs,	T _j =125℃		50		A
E _{rec}	Reverse Recovery	$V_{GE}=-15V$	T _j =25℃		1.2		an I
	Energy		T _j =125℃		3.3		mJ

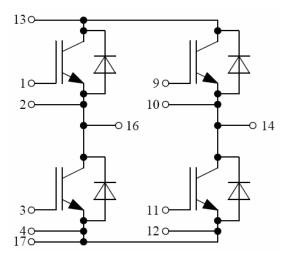
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IGBT Module

Symbol	Parameter	Min.	Тур.	Max.	Units
V _{ISO}	Isolation Voltage RMS,f=50Hz,t=1min		2500		V
L_{CE}	Stray Inductance		19		nН
R _{CC'+EE'}	Module Lead Resistance, Terminal to Chip @ T _C =25°C		2.5		mΩ
$R_{\theta JC}$	Junction-to-Case (per IGBT-inverter)			0.30	K/W
	Junction-to-Case (per DIODE-inverter)			0.49	
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)		0.02		K/W
T_j	Maximum Junction Temperature			150	$^{\circ}$
T_{STG}	Storage Temperature Range	-40		125	$^{\circ}$ C
Mounting	Mounting ConsynM5	3.0		6.0	NI an
Torque	Mounting Screw:M5			6.0	N.m
G	Weight of Module		200		g

GD50HCU120C5S IGBT Module

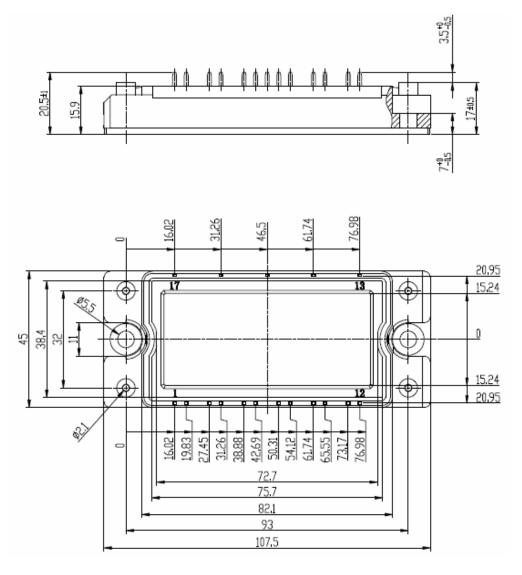
Equivalent Circuit Schematic



Pins 5,6,7,8,15 are not connected

Package Dimension

Dimensions in Millimeters



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